

# LMV821 Single/ LMV822 Dual/ LMV824 Quad Low Voltage, Low Power, R-to-R Output, 5 MHz Op Amps

## **General Description**

The LMV821/LMV822/LMV824 bring performance and economy to low voltage / low power systems. With a 5 MHz unity-gain frequency and a guaranteed 1.4 V/µs slew rate, the quiescent current is only 220 µA/amplifier (2.7 V). They provide rail-to-rail (R-to-R) output swing into heavy loads (600  $\Omega$  Guarantees). The input common-mode voltage range includes ground, and the maximum input offset voltage is 3.5mV (Guaranteed). They are also capable of comfortably driving large capacitive loads (refer to the application notes section).

The LMV821 (single) is available in the ultra tiny SC70-5 package, which is about half the size of the previous title holder, the SOT23-5.

Overall, the LMV821/LMV822/LMV824 (Single/Dual/Quad) are low voltage, low power, performance op amps, that can be designed into a wide range of applications, at an economical price.

#### **Features**

(For Typical, 5 V Supply Values; Unless Otherwise Noted)

- Ultra Tiny, SC70-5 Package
- Guaranteed 2.5 V, 2.7 V and 5 V Performance

■ Maximum VOS

3.5 mV (Guaranteed)

5 MHz

VOS Temp. Drift 1 uV/° C

GBW product @ 2.7 V

 $I_{Supply}$  @ 2.7 V 220 µA/Amplifier ■ Minimum SR 1.4 V/us (Guaranteed)

■ CMRR 90 dB

PSRR 85 dB

■ V<sub>CM</sub> @ 5V -0.3V to 4.3V

■ Rail-to-Rail (R-to-R) Output Swing

160 mV from rail - @600  $\Omega$  Load - @10 k $\Omega$  Load 55 mV from rail

■ Stable with High Capacitive Loads (Refer to Application Section)

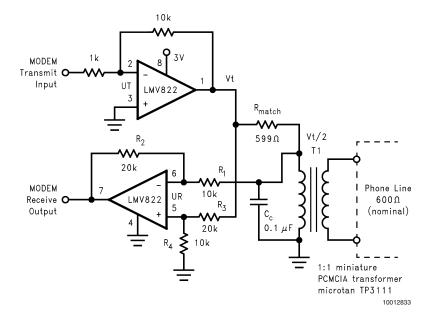
## **Applications**

- Cordless Phones
- Cellular Phones
- Laptops
- PDAs

2.0 x 2.0 x 1.0 mm

■ PCMCIA

## Telephone-line Transceiver for a **PCMCIA Modem Card**



## **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

ESD Tolerance (Note 2)

Machine Model 100V

Human Body Model

LMV822/824 2000V LMV821 1500V

Differential Input Voltage  $\pm$  Supply Voltage Supply Voltage (V<sup>+</sup>–V<sup>-</sup>) 5.5V

Output Short Circuit to  $V^+$  (Note 3) Output Short Circuit to  $V^-$  (Note 3)

Soldering Information

Infrared or Convection (20 sec) 235°C

Storage Temperature Range -65°C to 150°C Junction Temperature (Note 4) 150°C

## **Operating Ratings** (Note 1)

Supply Voltage 2.5V to 5.5V

Temperature Range

Thermal Resistance ( $\theta_{JA}$ )

Ultra Tiny SC70-5 Package, 5-Pin

Surface Mount 440 °C/W

Tiny SOT23-5 Package, 5-Pin

Surface Mount 265 °C/W SO Package, 8-Pin Surface Mount 190 °C/W

MSOP Package, 8-Pin Mini

Surface Mount 235 °C/W

SO Package, 14-Pin Surface

Mount 145 °C/W TSSOP Package, 14-Pin 155 °C/W

## 2.7V DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for  $T_J$  = 25°C.  $V^+$  = 2.7V,  $V^-$  = 0V,  $V_{CM}$  = 1.0V,  $V_O$  = 1.35V and  $R_L$  > 1  $M\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol Parameter		Condition	Typ (Note 5)	LMV821/822/824 Limit (Note 6)	Units
V <sub>os</sub>	Input Offset Voltage		1	3.5	mV
				4	max
TCV <sub>os</sub>	Input Offset Voltage Average Drift		1		μV/°C
I <sub>B</sub>	Input Bias Current		30	90	nA
				140	max
I <sub>os</sub>	Input Offset Current		0.5	30	nA
				50	max
CMRR	Common Mode Rejection Ratio	$0V \le V_{CM} \le 1.7V$	85	70	dB
				68	min
	Positive Power Supply Rejection	$1.7V \le V^+ \le 4V, V^- = 1V, V_O =$	85	75	dB
	Ratio	0V, V <sub>CM</sub> = 0V		70	min
-PSRR	Negative Power Supply	$-1.0V \le V^- \le -3.3V, V^+ = 1.7V,$	85	73	dB
	Rejection Ratio	$V_O = 0V, V_{CM} = 0V$		70	min
V <sub>CM</sub>	Input Common-Mode Voltage	For CMRR ≥ 50dB	-0.3	-0.2	V
	Range				max
			2.0	1.9	V
					min
A <sub>V</sub>	Large Signal Voltage Gain	Sourcing, $R_L = 600\Omega$ to 1.35V,	100	90	dB
		V <sub>O</sub> = 1.35V to 2.2V		85	min
		Sinking, $R_L = 600\Omega$ to 1.35V,	90	85	dB
		$V_{\rm O} = 1.35 V$ to 0.5 V		80	min
		Sourcing, $R_L = 2k\Omega$ to 1.35V,	100	95	dB
		V <sub>O</sub> = 1.35V to 2.2V		90	min
		Sinking, $R_L = 2k\Omega$ to 1.35, $V_O =$	95	90	dB
		1.35 to 0.5V		85	min

## 2.7V DC Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for  $T_J = 25^{\circ}C$ .  $V^+ = 2.7V$ ,  $V^- = 0V$ ,  $V_{CM} = 1.0V$ ,  $V_O = 1.35V$  and  $R_L > 1$  M $\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Parameter Condition		LMV821/822/824 Limit (Note 6)	Units
V <sub>O</sub>	Output Swing	$V^+ = 2.7V$ , $R_L = 600\Omega$ to 1.35V	2.58	2.50	V
				2.40	min
			0.13	0.20	V
				0.30	max
		$V^{+} = 2.7V$ , $R_{L} = 2k\Omega$ to 1.35V	2.66	2.60	V
				2.50	min
			0.08	0.120	V
				0.200	max
Io	Output Current	Sourcing, V <sub>O</sub> = 0V	16	12	mA
					min
		Sinking, $V_O = 2.7V$	26	12	mA
					min
Is	Supply Current	LMV821 (Single)	0.22	0.3	mA
				0.5	max
		LMV822 (Dual)	0.45	0.6	mA
				0.8	max
		LMV824 (Quad)	0.72	1.0	mA
				1.2	max

## 2.5V DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for  $T_J$  = 25°C.  $V^+$  = 2.5V,  $V^-$  = 0V,  $V_{CM}$  = 1.0V,  $V_O$  = 1.25V and R  $_L$  > 1 M $\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Condition	Typ (Note 5)	LMV821/822/824 Limit (Note 6)	Units
Vos	Input Offset Voltage		1	3.5	mV
				4	max
V <sub>o</sub>	Output Swing	$V^{+} = 2.5V$ , $R_{L} = 600\Omega$ to 1.25V	2.37	2.30	V
				2.20	min
			0.13	0.20	V
				0.30	max
		$V^{+} = 2.5V$ , $R_{L} = 2k\Omega$ to 1.25V	2.46	2.40	V
				2.30	min
			0.08	0.12	V
				0.20	max

## 2.7V AC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for  $T_J$  = 25°C.  $V^+$  = 2.7V,  $V^-$  = 0V,  $V_{CM}$  = 1.0V,  $V_O$  = 1.35V and R  $_L$  > 1 M $\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ (Note 5)	LMV821/822/824 Limit (Note 6)	Units
SR	Slew Rate	(Note 7)	1.5		V/µs
GBW	Gain-Bandwdth Product		5		MHz
$\Phi_{m}$	Phase Margin		61		Deg.
G <sub>m</sub>	Gain Margin		10		dB
	Amp-to-Amp Isolation	(Note 8)	135		dB
e <sub>n</sub>	Input-Related Voltage Noise	f = 1 kHz, V <sub>CM</sub> = 1V	28		nV √Hz

## 2.7V AC Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for  $T_J$  = 25°C. V<sup>+</sup> = 2.7V, V <sup>-</sup> = 0V, V<sub>CM</sub> = 1.0V, V<sub>O</sub> = 1.35V and R<sub>L</sub> > 1 M $\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ (Note 5)	LMV821/822/824 Limit (Note 6)	Units
i <sub>n</sub>	Input-Referred Current Noise	f = 1 kHz	0.1		pA √Hz
THD	Total Harmonic Distortion	f = 1 kHz, $A_V = -2$ , $R_L = 10 kΩ$ , $V_O = 4.1 V_{PP}$	0.01		%

## **5V DC Electrical Characteristics**

Unless otherwise specified, all limits guaranteed for  $T_J = 25^{\circ}C$ .  $V^+ = 5V$ ,  $V^- = 0V$ ,  $V_{CM} = 2.0V$ ,  $V_O = 2.5V$  and  $R_L > 1$  M $\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Condition	Typ (Note 5)	LMV821/822/824 Limit (Note 6)	Units	
V <sub>os</sub>	Input Offset Voltage		1	3.5	mV	
				4.0	max	
TCV <sub>os</sub>	Input Offset Voltage Average Drift		1		μV/°C	
I <sub>B</sub>	Input Bias Current		40	100	nA	
				150	max	
I <sub>os</sub>	Input Offset Current		0.5	30	nA	
				50	max	
CMRR	Common Mode Rejection Ratio	$0V \le V_{CM} \le 4.0V$	90	72	dB	
				70	min	
+PSRR	Positive Power Supply Rejection	$1.7V \le V^+ \le 4V, V^- = 1V, V_O =$	85	75	dB	
	Ratio	0V, V <sub>CM</sub> = 0V		70	min	
-PSRR	Negative Power Supply	$-1.0V \le V^- \le -3.3V, V^+ = 1.7V,$	85	73	dB	
	Rejection Ratio	$V_O = 0V, V_{CM} = 0V$		70	min	
$V_{CM}$	Input Common-Mode Voltage	For CMRR ≥ 50dB	-0.3	-0.2	V	
	Range				max	
			4.3	4.2	V	
					min	
A <sub>V</sub>	Large Signal Voltage Gain	Sourcing, $R_L = 600\Omega$ to 2.5V,	105	95	dB	
		$V_{\rm O} = 2.5 \text{ to } 4.5 \text{V}$		90	min	
		Sinking, $R_L = 600\Omega$ to 2.5V, $V_O$	105	95	dB	
		= 2.5 to 0.5V		90	min	
		Sourcing, $R_L = 2k\Omega$ to 2.5V, $V_O$	105	95	dB	
		= 2.5 to 4.5V		90	min	
		Sinking, $R_L = 2k\Omega$ to 2.5, $V_O =$	105	95	dB	
		2.5 to 0.5V		90	min	
V <sub>o</sub>	Output Swing	$V^{+} = 5V, R_{L} = 600\Omega$ to 2.5V	4.84	4.75	V	
				4.70	min	
			0.17	0.250	V	
				.30	max	
		$V^{+} = 5V, R_{L} = 2k\Omega \text{ to } 2.5V$	4.90	4.85	V	
				4.80	min	
			0.10	0.15	V	
				0.20	max	

## **5V DC Electrical Characteristics** (Continued)

Unless otherwise specified, all limits guaranteed for  $T_J = 25^{\circ}C$ .  $V^+ = 5V$ ,  $V^- = 0V$ ,  $V_{CM} = 2.0V$ ,  $V_O = 2.5V$  and  $R_L > 1$  M $\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Condition	Typ (Note 5)	LMV821/822/824 Limit (Note 6)	Units
Io	Output Current	Sourcing, V <sub>O</sub> = 0V	45	20	mA
				15	min
		Sinking, $V_O = 5V$	40	20	mA
				15	min
Is	Supply Current	LMV821 (Single)	0.30	0.4	mA
				0.6	max
		LMV822 (Dual)	0.5	0.7	mA
				0.9	max
		LMV824 (Quad)	1.0	1.3	mA
				1.5	max

#### **5V AC Electrical Characteristics**

Unless otherwise specified, all limits guaranteed for  $T_J$  = 25°C.  $V^+$  = 5V,  $V^-$  = 0V,  $V_{CM}$  = 2V,  $V_O$  = 2.5V and R  $_L$  > 1 M $\Omega$ . **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ (Note 5)	LMV821/822/824 Limit (Note 6)	Units	
SR	Slew Rate	(Note 7)	2.0	1.4	V/µs min	
GBW	Gain-Bandwdth Product		5.6		MHz	
$\Phi_{m}$	Phase Margin		67		Deg.	
G <sub>m</sub>	Gain Margin		15		dB	
	Amp-to-Amp Isolation	(Note 8)	135		dB	
e <sub>n</sub>	Input-Related Voltage Noise	f = 1 kHz, V <sub>CM</sub> = 1V	24		<u>nV</u> √Hz	
i <sub>n</sub>	Input-Referred Current Noise	f = 1 kHz	0.25		pA √Hz	
THD	Total Harmonic Distortion	$f = 1 \text{ kHz}, A_V = -2,$ $R_L = 10 \text{ k}Ω, V_O = 4.1 \text{ V}_{PP}$	0.01		%	

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.

Note 2: Human body model, 1.5 k $\Omega$  in series with 100 pF. Machine model, 200 $\Omega$  in series with 100 pF.

Note 3: Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of 45 mA over long term may adversely affect reliability.

Note 4: The maximum power dissipation is a function of  $T_{J(max)}$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(max)} - T_A)/\theta_{JA}$ . All numbers apply for packages soldered directly into a PC board.

Note 5: Typical Values represent the most likely parametric norm.

Note 6: All limits are guaranteed by testing or statistical analysis.

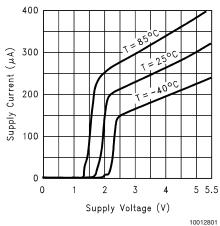
Note 7: V<sup>+</sup> = 5V. Connected as voltage follower with 3V step input. Number specified is the slower of the positive and negative slew rates.

Note 8: Input referred,  $V^+$  = 5V and  $R_L$  = 100k $\Omega$  connected to 2.5V. Each amp excited in turn with 1 kHz to produce  $V_0$  = 3  $V_{PP}$ .

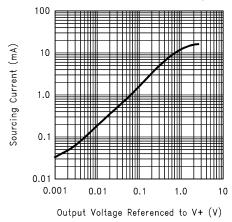
## **Typical Performance Characteristics**

Unless otherwise specified,  $V_S = +5V$ , single supply,  $T_A = 25^{\circ}C$ .

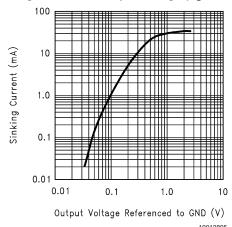
### Supply Current vs. Supply Voltage (LMV821)



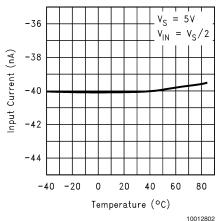
#### Sourcing Current vs. Output Voltage $(V_S = 2.7V)$



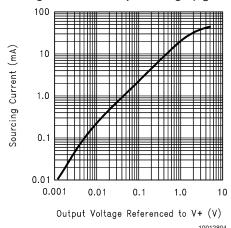
#### Sinking Current vs. Output Voltage ( $V_S = 2.7V$ )



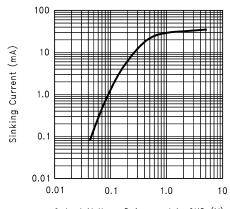
### Input Current vs. Temperature



## Sourcing Current vs Output Voltage ( $V_S = 5V$ )



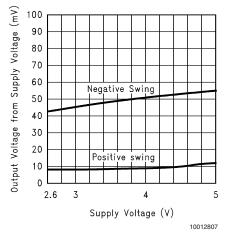
#### Sinking Current vs. Output Voltage $(V_S = 5V)$



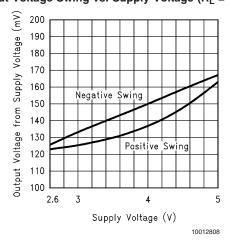
Output Voltage Referenced to GND (V)

 $T_A = 25$ °C. (Continued)

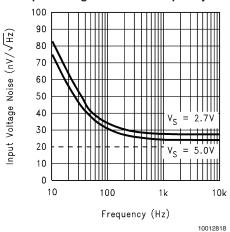
#### Output Voltage Swing vs. Supply Voltage ( $R_L = 10k\Omega$ )



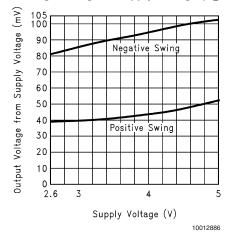
## Output Voltage Swing vs. Supply Voltage ( $R_L = 600\Omega$ )



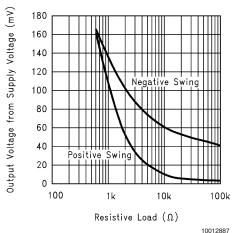
#### Input Voltage Noise vs. Frequency



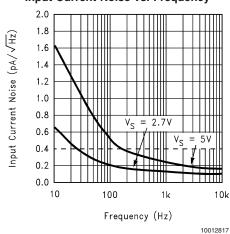
#### Output Voltage Swing vs. Supply Voltage ( $R_L = 2k\Omega$ )



### Output Voltage Swing vs. Load Resistance

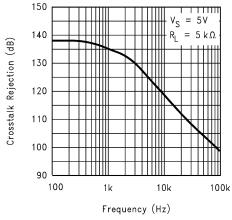


#### Input Current Noise vs. Frequency



 $T_A = 25$ °C. (Continued)

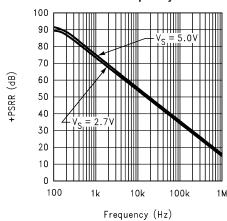
#### Crosstalk Rejection vs. Frequency



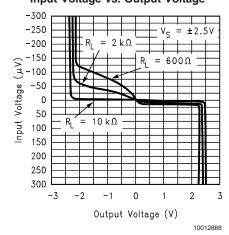
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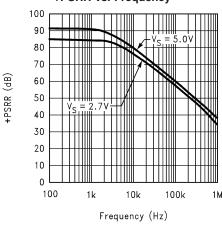
#### -PSRR vs. Frequency



Input Voltage vs. Output Voltage

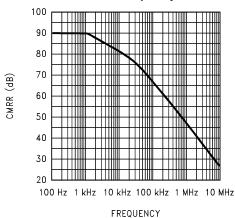


+PSRR vs. Frequency



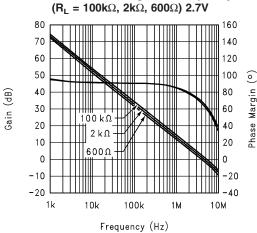
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#### CMRR vs. Frequency



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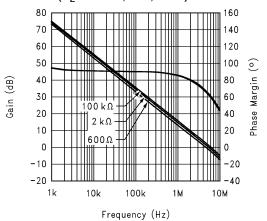
## Gain and Phase Margin vs. Frequency (R. = 100kO 2kO 600O) 2 7V



10012811

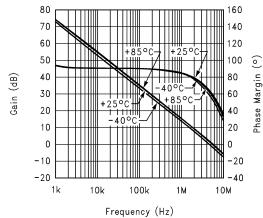
 $T_A = 25$ °C. (Continued)

# Gain and Phase Margin vs. Frequency (R<sub>I</sub> = 100k $\Omega$ , 2k $\Omega$ , 600 $\Omega$ ) 5V



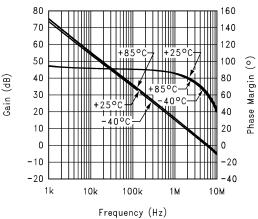
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# Gain and Phase Margin vs. Frequency (Temp.= 25, -40, 85°C, $R_L = 10k\Omega$ ) 2.7V



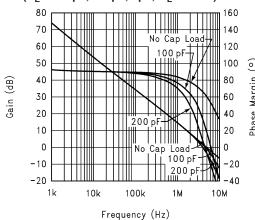
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# Gain and Phase Margin vs. Frequency (Temp.= 25, -40, 85 $^{\circ}$ C, R<sub>L</sub> = 10k $\Omega$ ) 5V



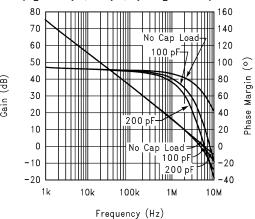
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# Gain and Phase Margin vs. Frequency (C<sub>L</sub> = 100pF, 200pF, 0pF, R<sub>L</sub> = 10k $\Omega$ )2.7V



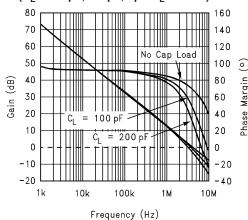
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# Gain and Phase Margin vs. Frequency (C $_{L}$ = 100pF, 200pF, 0pF $R_{L}$ = 10k $\Omega$ ) 5V



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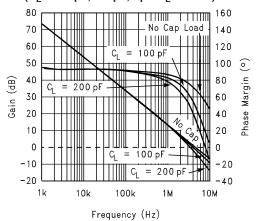
# Gain and Phase Margin vs. Frequency (C $_L$ = 100pF, 200pF, 0pF $R_L$ = 600 $\!\Omega$ ) 2.7V



10012819

 $T_A = 25$ °C. (Continued)

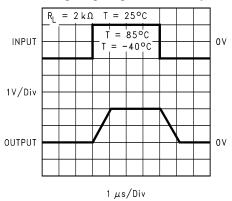
# Gain and Phase Margin vs. Frequency ( $C_L = 100pF$ , 200pF, 0pF $R_L = 600\Omega$ ) 5V



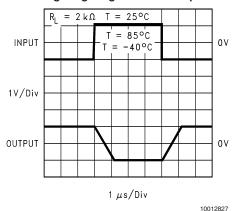
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10012821

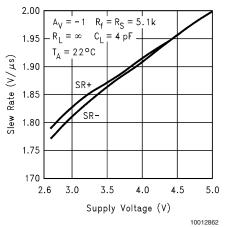
#### Non-Inverting Large Signal Pulse Response



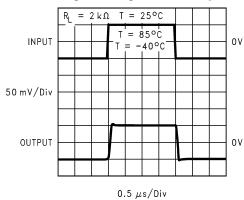
**Inverting Large Signal Pulse Response** 



Slew Rate vs. Supply Voltage

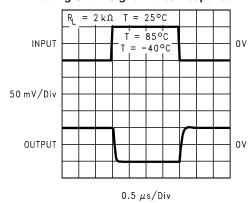


Non-Inverting Small Signal Pulse Response



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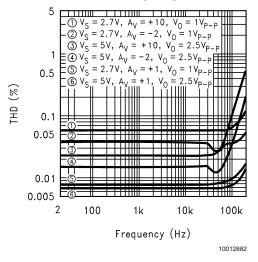
#### **Inverting Small Signal Pulse Response**



10012830

 $T_A = 25$ °C. (Continued)

#### THD vs. Frequency



## **Application Note**

This application note is divided into two sections: design considerations and Application Circuits.

#### **DESIGN CONSIDERATIONS**

This section covers the following design considerations:

- 1. Frequency and Phase Response Considerations
- 2. Unity-Gain Pulse Response Considerations
- 3. Input Bias Current Considerations

# FREQUENCY AND PHASE RESPONSE CONSIDERATIONS

The relationship between open-loop frequency response and open-loop phase response determines the closed-loop stability performance (negative feedback). The open-loop phase response causes the feedback signal to shift towards becoming positive feedback, thus becoming unstable. The further the output phase angle is from the input phase angle, the more stable the negative feedback will operate. Phase Margin  $(\phi_m)$  specifies this output-to-input phase relationship at the unity-gain crossover point. Zero degrees of phasemargin means that the input and output are completely in phase with each other and will sustain oscillation at the unity-gain frequency.

The AC tables show  $\phi_m$  for a no load condition. But  $\phi_m$  changes with load. The Gain and Phase margin vs Frequency plots in the curve section can be used to graphically determine the  $\phi_m$  for various loaded conditions. To do this, examine the phase angle portion of the plot, find the phase margin point at the unity-gain frequency, and determine how far this point is from zero degree of phase-margin. The larger the phase-margin, the more stable the circuit operation.

The bandwidth is also affected by load. The graphs of *Figure 1* and *Figure 2* provide a quick look at how various loads affect the  $\phi_m$  and the bandwidth of the LMV821/822/824 family. These graphs show capacitive loads reducing both  $\phi_m$  and bandwidth, while resistive loads reduce the bandwidth but increase the  $\phi_m$ . Notice how a  $600\Omega$  resistor can be

added in parallel with 220 picofarads capacitance, to increase the  $\varphi_m$  20°(approx.), but at the price of about a 100 kHz of bandwidth.

Overall, the LMV821/822/824 family provides good stability for loaded condition.

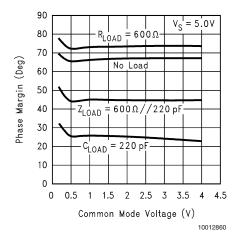


FIGURE 1. Phase Margin vs Common Mode Voltage for Various Loads

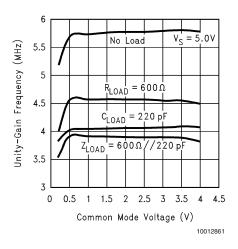


FIGURE 2. Unity-Gain Frequency vs Common Mode Voltage for Various Loads

#### **UNITY GAIN PULSE RESPONSE CONSIDERATION**

A pull-up resistor is well suited for increasing unity-gain, pulse response stability. For example, a 600  $\Omega$  pull-up resistor reduces the overshoot voltage by about 50%, when driving a 220 pF load. *Figure 3* shows how to implement the pull-up resistor for more pulse response stability.

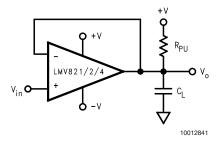


FIGURE 3. Using a Pull-up Resistor at the Output for Stabilizing Capacitive Loads

Higher capacitances can be driven by decreasing the value of the pull-up resistor, but its value shouldn't be reduced beyond the sinking capability of the part. An alternate approach is to use an isolation resistor as illustrated in *Figure 4* 

Figure 5 shows the resulting pulse response from a LMV824, while driving a 10,000 pF load through a  $20\Omega$  isolation resistor.

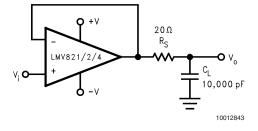


FIGURE 4. Using an Isolation Resistor to Drive Heavy Capacitive Loads

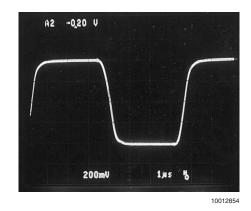


FIGURE 5. Pulse Response per Figure 4

#### INPUT BIAS CURRENT CONSIDERATION

Input bias current (I<sub>B</sub>) can develop a somewhat significant offset voltage. This offset is primarily due to I<sub>B</sub> flowing through the negative feedback resistor, R<sub>F</sub>. For example, if I<sub>B</sub> is 90 nA (max @ room) and R<sub>F</sub> is 100 k $\Omega$ , then an offset of 9 mV will be developed (V<sub>OS</sub>=I<sub>B</sub>x R<sub>F</sub>).Using a compensation resistor (R<sub>C</sub>), as shown in *Figure 6*, cancels out this affect. But the input offset current (I<sub>OS</sub>) will still contribute to an offset voltage in the same manner - typically 0.05 mV at room temp.

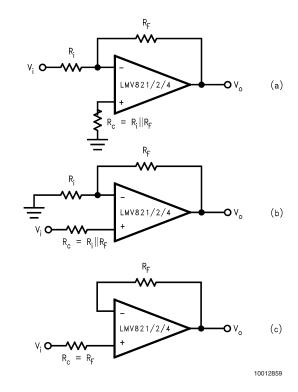


FIGURE 6. Canceling the Voltage Offset Effect of Input
Bias Current

#### **APPLICATION CIRCUITS**

This section covers the following application circuits:

1. Telephone-Line Transceiver

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2. "Simple" Mixer (Amplitude Modulator)

- 3. Dual Amplifier Active Filters (DAAFs)
- a. Low-Pass Filter (LPF)
- b. High-Pass Filter (HPF)
- 4. Tri-level Voltage Detector

#### **TELEPHONE-LINE TRANSCEIVER**

The telephone-line transceiver of Figure 7 provides a full-duplexed connection through a PCMCIA, miniature transformer. The differential configuration of receiver portion (UR), cancels reception from the transmitter portion (UT). Note that the input signals for the differential configuration of UR, are the transmit voltage (V<sub>T</sub>) and V<sub>T</sub>/2. This is because  $R_{\rm match}$  is chosen to match the coupled telephone-line impedance; therefore dividing V<sub>T</sub> by two (assuming R1 >>  $R_{\rm match}$ ). The differential configuration of UR has its resistors chosen to cancel the V<sub>T</sub> and V<sub>T</sub>/2 inputs according to the following equation:

$$V_{0} = V_{T} \left( \frac{R_{4}}{R_{3} + R_{4}} \right) \left( 1 + \frac{R_{2}}{R_{1}} \right) - \frac{V_{T}}{2} \left( \frac{R_{2}}{R_{1}} \right) = V_{T} \frac{1}{3} (3) - \frac{V_{T}}{2} (2) = 0$$

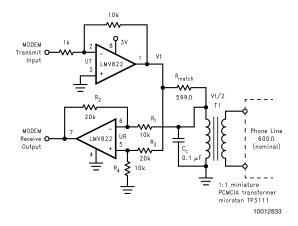


FIGURE 7. Telephone-line Transceiver for a PCMCIA Modem Card

Note that Cr is included for canceling out the inadequacies of the lossy, miniature transformer. Refer to application note AN-397 for detailed explanation.

#### "SIMPLE" MIXER (AMPLITUDE MODULATOR)

The mixer of Figure 8 is simple and provides a unique form of amplitude modulation. Vi is the modulation frequency  $(\mathsf{F}_\mathsf{M}),$  while a +3V square-wave at the gate of Q1, induces a carrier frequency  $(\mathsf{F}_\mathsf{C}).$  Q1 switches (toggles) U1 between inverting and non-inverting unity gain configurations. Offsetting a sine wave above ground at Vi results in the oscilloscope photo of Figure 9.

The simple mixer can be applied to applications that utilize the Doppler Effect to measure the velocity of an object. The difference frequency is one of its output frequency components. This difference frequency magnitude ( $F_{\text{M}}$ - $F_{\text{C}}$ /) is the key factor for determining an object's velocity per the Doppler Effect. If a signal is transmitted to a moving object, the reflected frequency will be a different frequency. This difference in transmit and receive frequency is directly proportional to an object's velocity.

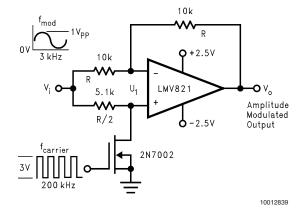


FIGURE 8. Amplitude Modulator Circuit

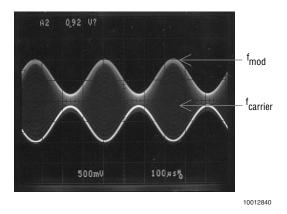


FIGURE 9. Output signal per the Circuit of Figure 8

#### **DUAL AMPLIFIER ACTIVE FILTERS (DAAFs)**

The LMV822/24 bring economy and performance to DAAFs. The low-pass and the high-pass filters of *Figure 10* and *Figure 11* (respectively), offer one key feature: excellent sensitivity performance. Good sensitivity is when deviations in component values cause relatively small deviations in a filter's parameter such as cutoff frequency (Fc). Single amplifier active filters like the Sallen-Key provide relatively poor sensitivity performance that sometimes cause problems for high production runs; their parameters are much more likely to deviate out of specification than a DAAF would. The DAAFs of *Figure 10* and *Figure 11* are well suited for high volume production.

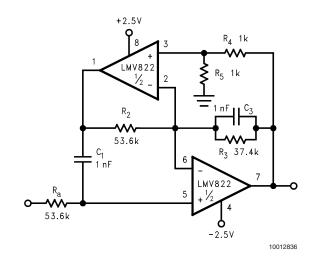


FIGURE 10. Dual Amplifier, 3 kHz Low-Pass Active Filter with a Butterworth Response and a Pass Band Gain of Times Two

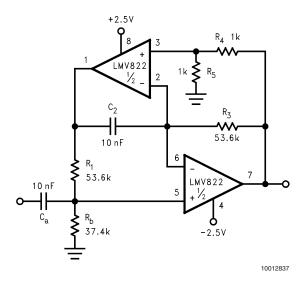


FIGURE 11. Dual Amplifier, 300 Hz High-Pass Active Filter with a Butterworth Response and a Pass Band Gain of Times Two

Table 1 provides sensitivity measurements for a 10  $M\Omega$  load condition. The left column shows the passive components for the 3 kHz low-pass DAAF. The third column shows the components for the 300 Hz high-pass DAAF. Their respective sensitivity measurements are shown to the right of each component column. Their values consists of the percent change in cutoff frequency (Fc) divided by the percent change in component value. The lower the sensitivity value, the better the performance.

Each resistor value was changed by about 10 percent, and this measured change was divided into the measured change in Fc. A positive or negative sign in front of the measured value, represents the direction Fc changes relative to components' direction of change. For example, a sensitivity value of negative 1.2, means that for a 1 percent increase in component value, Fc decreases by 1.2 percent.

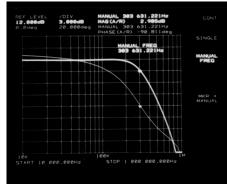
Note that this information provides insight on how to fine tune the cutoff frequency, if necessary. It should be also noted that  $\rm R_4$  and  $\rm R_5$  of each circuit also caused variations in the pass band gain. Increasing  $\rm R_4$  by ten percent, increased the gain by 0.4 dB, while increasing  $\rm R_5$  by ten percent, decreased the gain by 0.4 dB.

TABLE 1.

Component (LPF)	Sensitivity (LPF)	Component (HPF)	Sensitivity (HPF)
Ra	-1.2	Ca	-0.7
C <sub>1</sub>	-0.1	R <sub>b</sub>	-1.0
R <sub>2</sub>	-1.1	R <sub>1</sub>	+0.1
R <sub>3</sub>	+0.7	C <sub>2</sub>	-0.1
C <sub>3</sub>	-1.5	R <sub>3</sub>	+0.1
R <sub>4</sub>	-0.6	R <sub>4</sub>	-0.1
R <sub>5</sub>	+0.6	R <sub>5</sub>	+0.1

Active filters are also sensitive to an op amp's parameters -Gain and Bandwidth, in particular. The LMV822/24 provide a large gain and wide bandwidth. And DAAFs make excellent use of these feature specifications.

Single Amplifier versions require a large open-loop to closed-loop gain ratio - approximately 50 to 1, at the Fc of the filter response. *Figure 12* shows an impressive photograph of a network analyzer measurement (hp3577A). The measurement was taken from a 300 kHz version of *Figure 10*. At 300 kHz, the open-loop to closed-loop gain ratio @ Fc is about 5 to 1. This is 10 times lower than the 50 to 1 "rule of thumb" for Single Amplifier Active Filters.



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FIGURE 12. 300 kHz, Low-Pass Filter, Butterworth Response as Measured by the HP3577A Network Analyzer

In addition to performance, DAAFs are relatively easy to design and implement. The design equations for the low-pass and high-pass DAAFs are shown below. The first two equation calculate the Fc and the circuit Quality Factor (Q) for the LPF (Figure 10). The second two equations calculate the Fc and Q for the HPF (Figure 11).

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$$\begin{array}{ll} \text{(LPF)} & F_{\text{C}} \; = \; \frac{\sqrt{R_5}}{2\pi\,\sqrt{R_a}\cdot\sqrt{R_2}\cdot\sqrt{R_4}\cdot\sqrt{C_1}\cdot\sqrt{C_3}} \\ & \text{Q} \; = \; 2\pi F_{\text{C}}\sqrt{C_1}\cdot\sqrt{C_3} \\ & \text{(HPF)} & F_{\text{C}} \; = \; \frac{\sqrt{R_4}}{2\pi\,\sqrt{R_1}\cdot\sqrt{R_3}\cdot\sqrt{R_5}\cdot\sqrt{C_a}\cdot\sqrt{C_2}} \\ & \text{Q} \; = \; 2\pi F_{\text{C}}\sqrt{C_a}\cdot\sqrt{C_2} \end{array}$$

To simplify the design process, certain components are set equal to each other. Refer to *Figure 10* and *Figure 11*. These equal component values help to simplify the design equations as follows:

To illustrate the design process/implementation, a 3 kHz, Butterworth response, low-pass filter DAAF (*Figure 10*) is designed as follows:

- 1. Choose  $C_1 = C_3 = C = 1 \text{ nF}$
- 2. Choose  $R_4 = R_5 = 1 \text{ k}\Omega$
- 3. Calculate R<sub>a</sub> and R<sub>2</sub> for the desired Fc as follows:

$$R_{a} = R_{2} = \frac{1}{2\pi(F_{C})C}$$

$$= \frac{1}{2\pi(3 \text{ kHz}) 1 \text{nF}}$$

$$= 53.1 \text{ k}\Omega$$

$$\cong 53.6 \text{ k}\Omega \text{ (Practical Value)}$$

4. Calculate  $R_3$  for the desired Q. The desired Q for a Butterworth (Maximally Flat) response is 0.707 (45 degrees into the s-plane).  $R_3$  calculates as follows:

$$R_3 = \frac{Q}{2\pi(F_C)C}$$

$$= \frac{0.707}{2\pi(3 \text{ kHz})1 \text{ nF}}$$

$$= 37.5 \text{ k}\Omega$$

$$\cong 37.4 \text{ k}\Omega \text{ (Practical Value)}$$

Notice that  $\rm R_3$  could also be calculated as 0.707 of  $\rm R_a$  or  $\rm R_2$ . The circuit was implemented and its cutoff frequency measured. The cutoff frequency measured at 2.92 kHz.

The circuit also showed good repeatability. Ten different LMV822 samples were placed in the circuit. The corresponding change in the cutoff frequency was less than a percent.

#### TRI-LEVEL VOLTAGE DETECTOR

The tri-level voltage detector of *Figure 13* provides a type of window comparator function. It detects three different input voltage ranges: Min-range, Mid-range, and Max-range. The output voltage (V $_{\rm O}$ ) is at V $_{\rm CC}$  for the Min-range. V $_{\rm O}$  is clamped at GND for the Mid-range. For the Max-range, V $_{\rm O}$  is at V $_{\rm ee}$ . *Figure 14* shows a V $_{\rm O}$  vs. V $_{\rm I}$  oscilloscope photo per the circuit of *Figure 13*.

Its operation is as follows:  $V_1$  deviating from GND, causes the diode bridge to absorb  $I_{\rm IN}$  to maintain a clamped condition ( $V_{\rm O}$ = 0V). Eventually,  $I_{\rm IN}$  reaches the bias limit of the diode bridge. When this limit is reached, the clamping effect stops and the op amp responds open loop. The design equation directly preceding *Figure 14*, shows how to determine the clamping range. The equation solves for the input voltage band on each side GND. The mid-range is twice this voltage band.

$$\Delta V = \frac{R}{R_1} (V_{CC} - V_{Diode})$$
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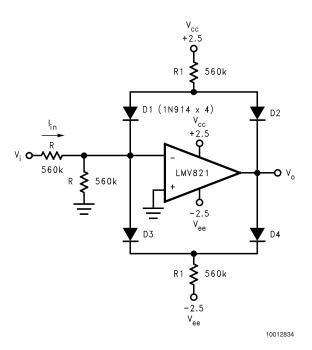


FIGURE 13. Tri-level Voltage Detector

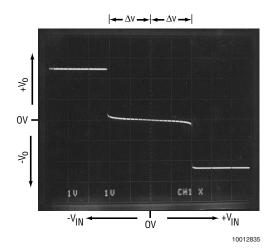
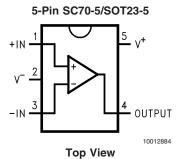
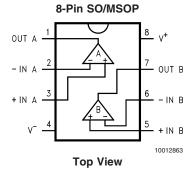
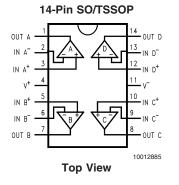


FIGURE 14. X, Y Oscilloscope Trace showing  $V_{OUT}$  vs  $V_{IN}$  per the Circuit of Figure 13

## **Connection Diagrams**



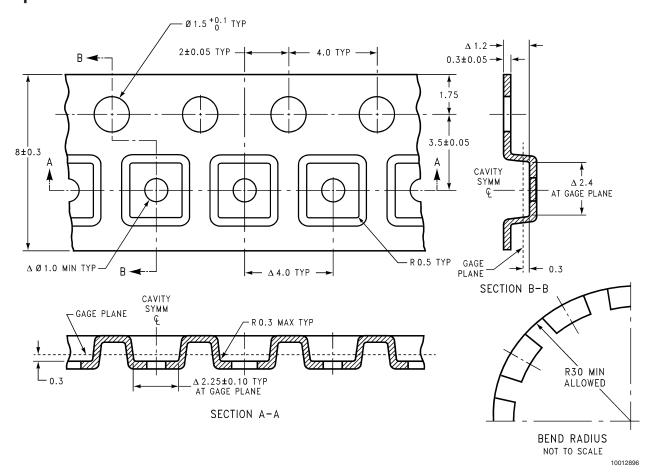




# **Ordering Information**

	Temperature Range			
Package	Industrial	Packaging Marking	Transport Media	<b>NSC Drawing</b>
	-40°C to +85°C			
5-Pin SC-70-5	LMV821M7	A15	1k Units Tape and Reel	MAA05
	LMV821M7X		3k Units Tape and Reel	
5-Pin SOT23-5	LMV821M5	A14	1k UnitsTape and Reel	MF05A
	LMV821M5X		3k Units Tape and Reel	
8-Pin SOIC	LMV822M	LMV822M	Rails	M08A
	LMV822MX		2.5k Units Tape and Reel	
8-Pin MSOP	LMV822MM	LMV822	1k Units Tape and Reel	MUA08A
	LMV822MMX		3.5k Units Tape and	
			Reel	
14-Pin SOIC	LMV824M	LMV824M	Rails	M14A
	LMV824MX		2.5k Units Tape and	
			Reel	
14-Pin TSSOP	LMV824MT	LMV824MT	Rails	MTC14
	LMV824MTX		2.5k Units Tape and	
			Reel	

# SC70-5 Tape and Reel Specification

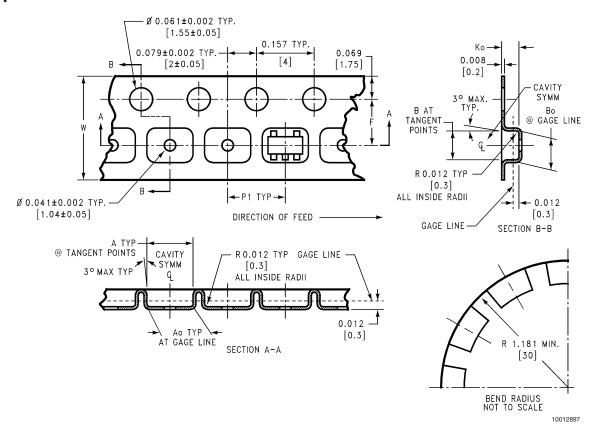


# **SOT-23-5 Tape and Reel Specification**

## **Tape Format**

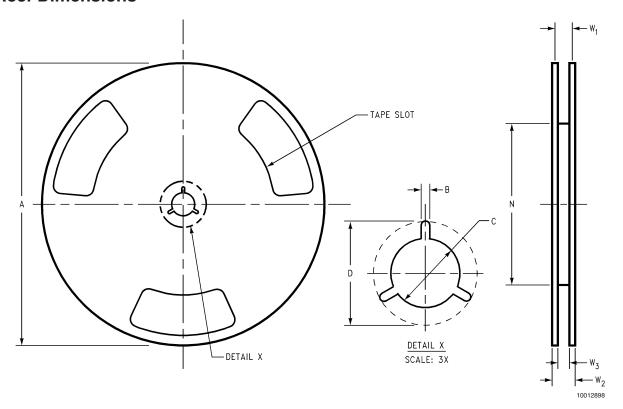
Tape Section	# Cavities	Cavity Status	Cover Tape Status	
Leader	0 (min)	Empty	Sealed	
(Start End)	75 (min)	Empty	Sealed	
Carrier	3000	Filled	Sealed	
	250	Filled	Sealed	
Trailer	Trailer 125 (min)		Sealed	
(Hub End)	0 (min)	Empty	Sealed	

## **Tape Dimensions**



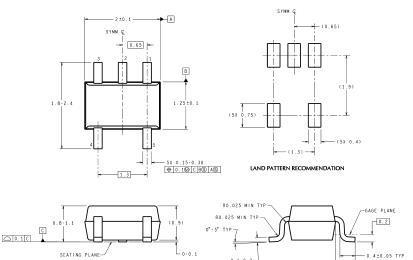
8 mm	0.130	0.124	0.130	0.126	0.138 ±0.002	0.055 ±0.004	0.157	0.315 ±0.012
	(3.3)	(3.15)	(3.3)	(3.2)	$(3.5 \pm 0.05)$	(1.4 ±0.11)	(4)	(8 ±0.3)
Tape Size	DIM A	DIM Ao	DIM B	DIM Bo	DIM F	DIM Ko	DIM P1	DIM W

## **Reel Dimensions**



8 mm	7.00	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1+ 0.078/-0.039
	330.00	1.50	13.00	20.20	55.00	8.40 + 1.50/-0.00	14.40	W1 + 2.00/-1.00
Tape Size	А	В	С	D	N	W1	W2	W3

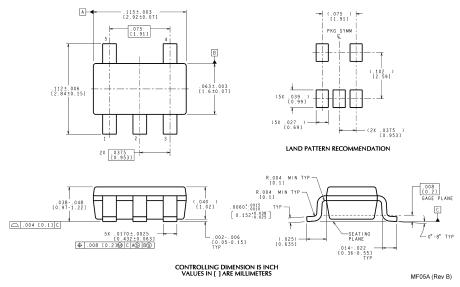
## Physical Dimensions inches (millimeters) unless otherwise noted



DIMENSIONS ARE IN MILLIMETERS

SC70-5

NS Package Number MAA05



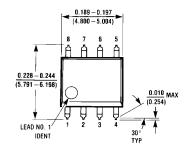
SOT 23-5 NS Package Number MF05A

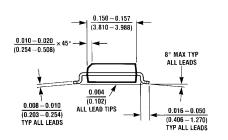
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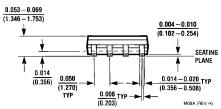
(0.515 TYP)

MAA05A (Rev C)

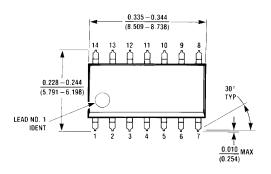
## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

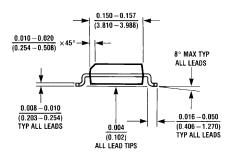


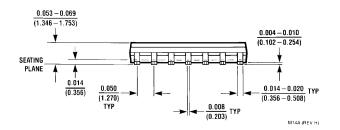




8-Pin Small Outline NS Package Number M08A







14-Pin Small Outline NS Package Number M14A

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued) .118 ± .004 Ç (.189) (8X .040 ) [1.02] .193±.006 [4.9±0.15] PIN 1 IDENT-LAND PATTERN RECOMMENDATION 6X .0256 [0.65] -GAGE PLANE R.005 TYP .004 [0.1] A .012\*:004 [0.3\*0.10 .021 ±.005 [0.53 ±0.12] -SEATING PLANE ф .002 [0.05]W BS CS (.0375 TYP) [0.953] CONTROLLING DIMENSION IS INCH VALUES IN [ ] ARE MILLIMETERS MUA08A (Rev E) 8-Pin MSOP NS Package Number MUA08A SYMM (5.94) 6.4 4.4±0.1 3.2 GAGE PLANE (14X 0,42) -0.25 (12X 0.65) -0.2 C B A ALL LEAD TIPS RECOMMENDED LAND PATTERN PIN #1 ID SEATING PLANE DETAIL A SEE DETAIL A 1.1 MAX TYP (0.9) Ç 0.1±0.05 TYP ALL LEAD TIPS ⊕ 0.13M A BS CS DIMENSIONS ARE IN MILLIMETERS DIMENSIONS IN ( ) FOR REFERENCE ONLY 12X 0.65 MTC14 (Rev D) 14-Pin TSSOP **NS Package Number MTC14**

### **Notes**

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